

FIG. 1

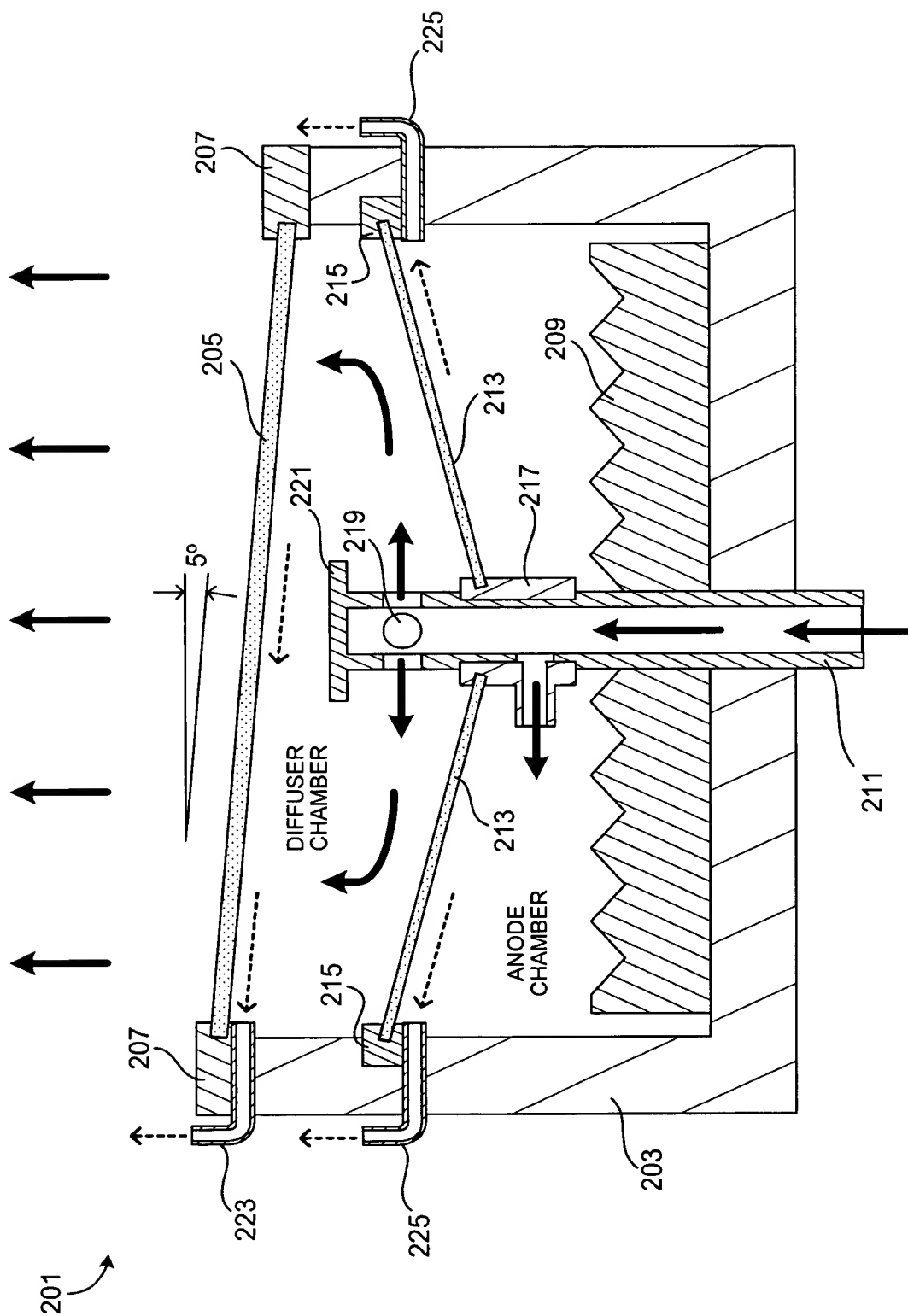


FIG. 2A

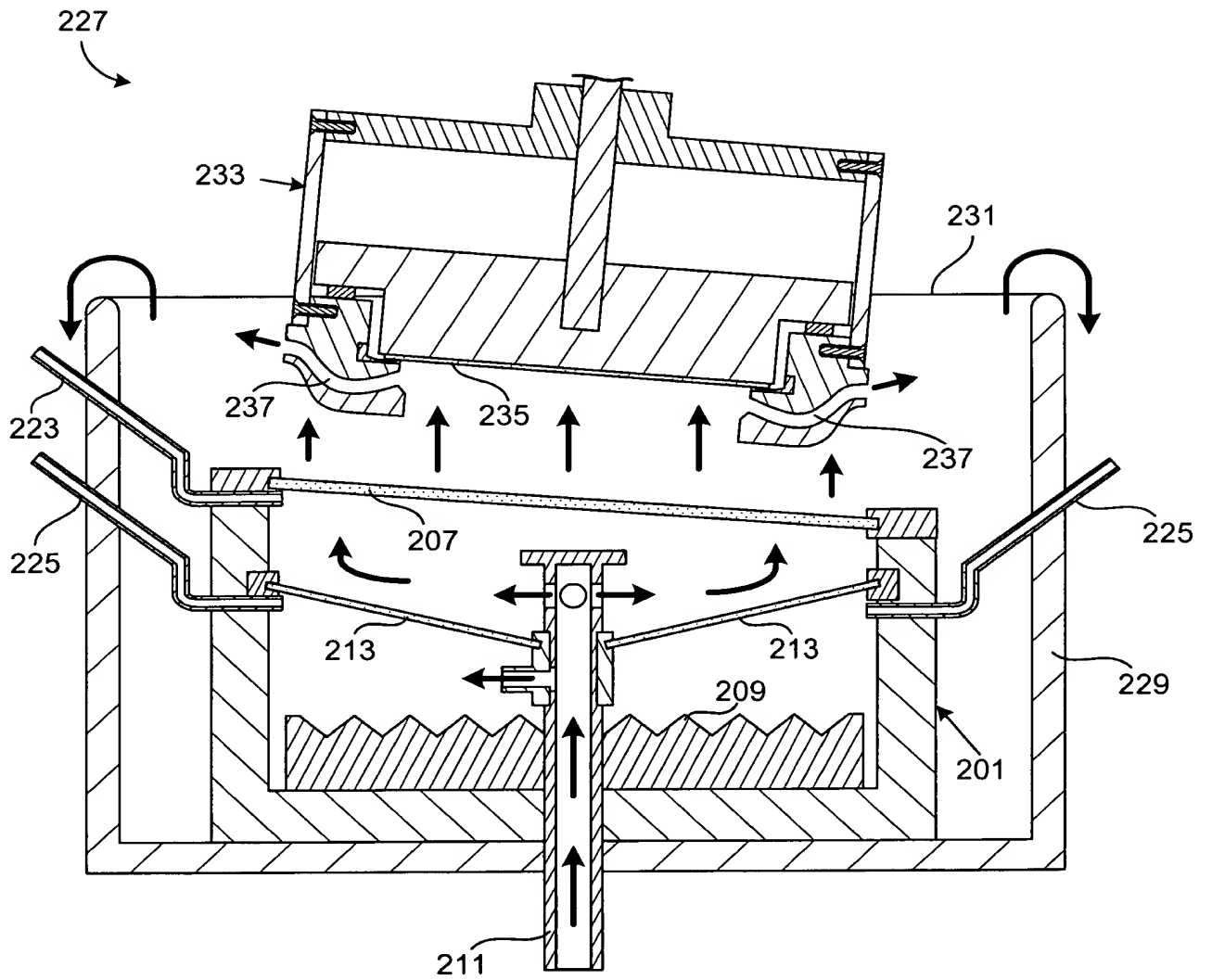


FIG. 2B

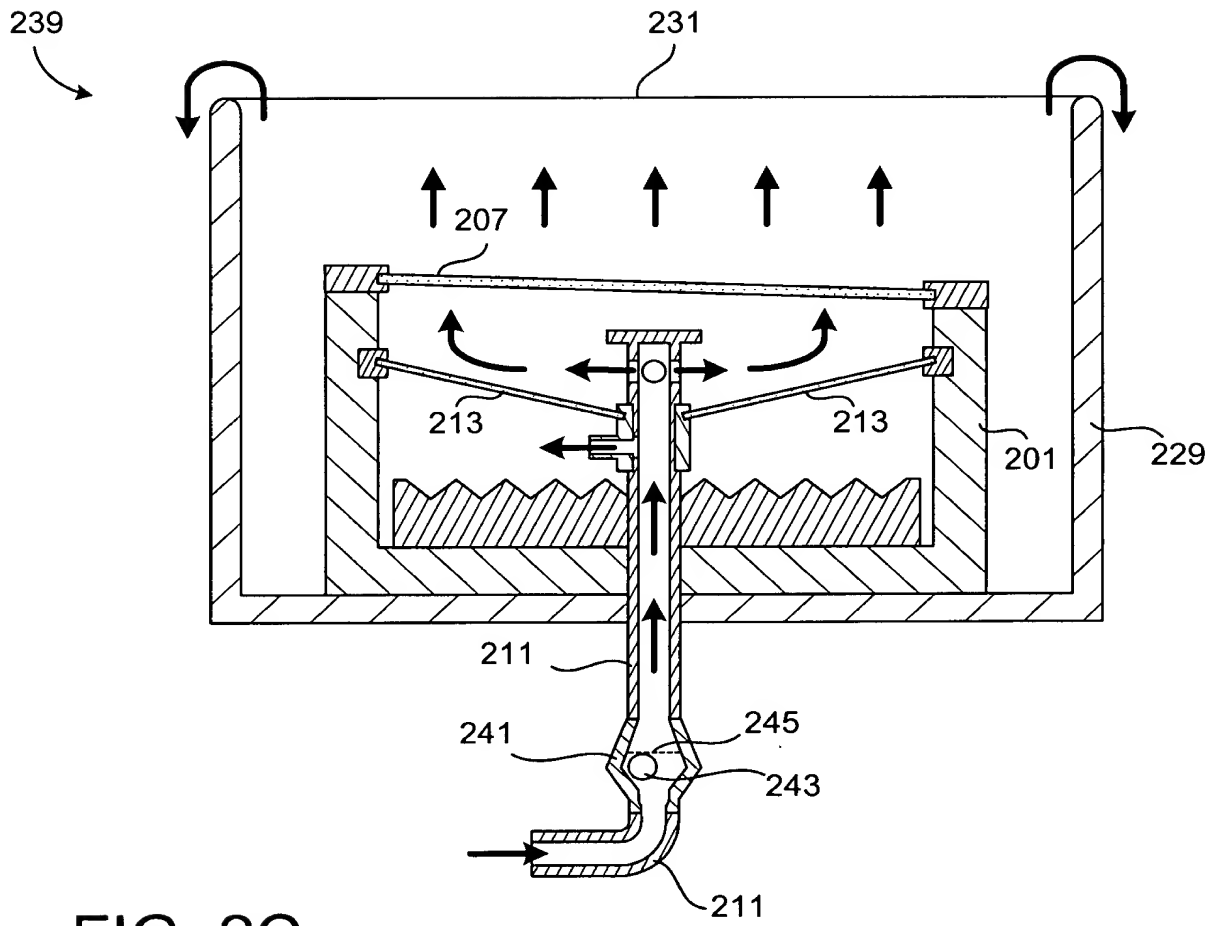


FIG. 2C

0992740-081001

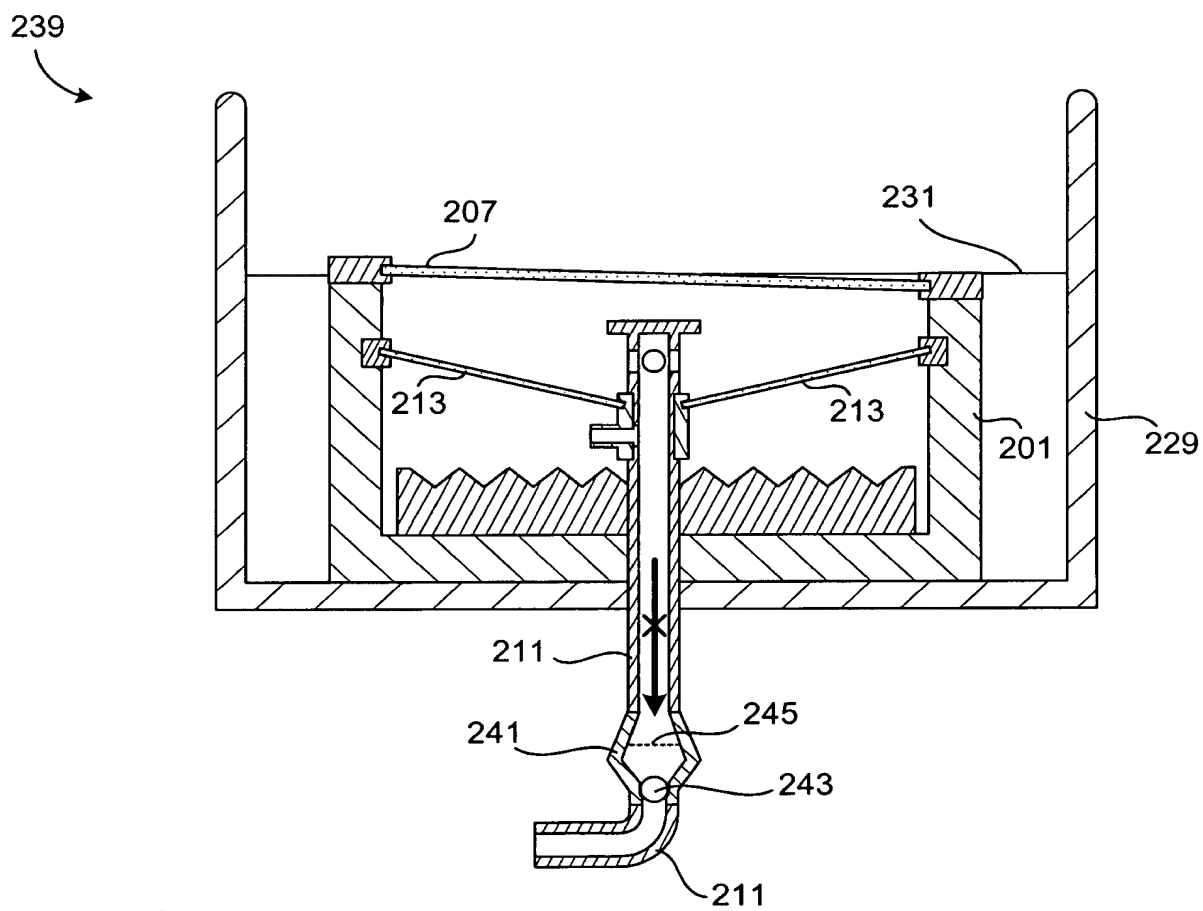


FIG. 2D

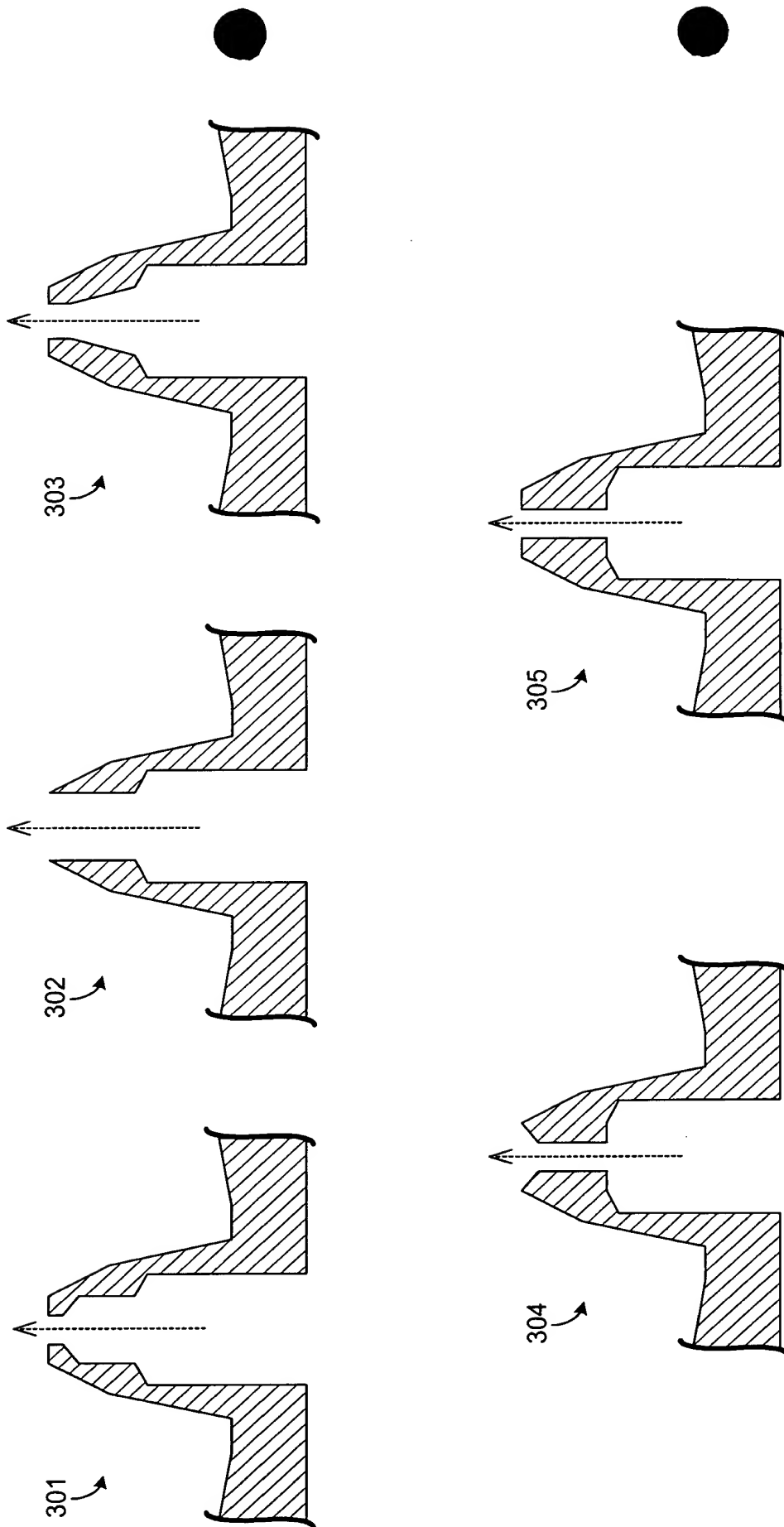


FIG. 3

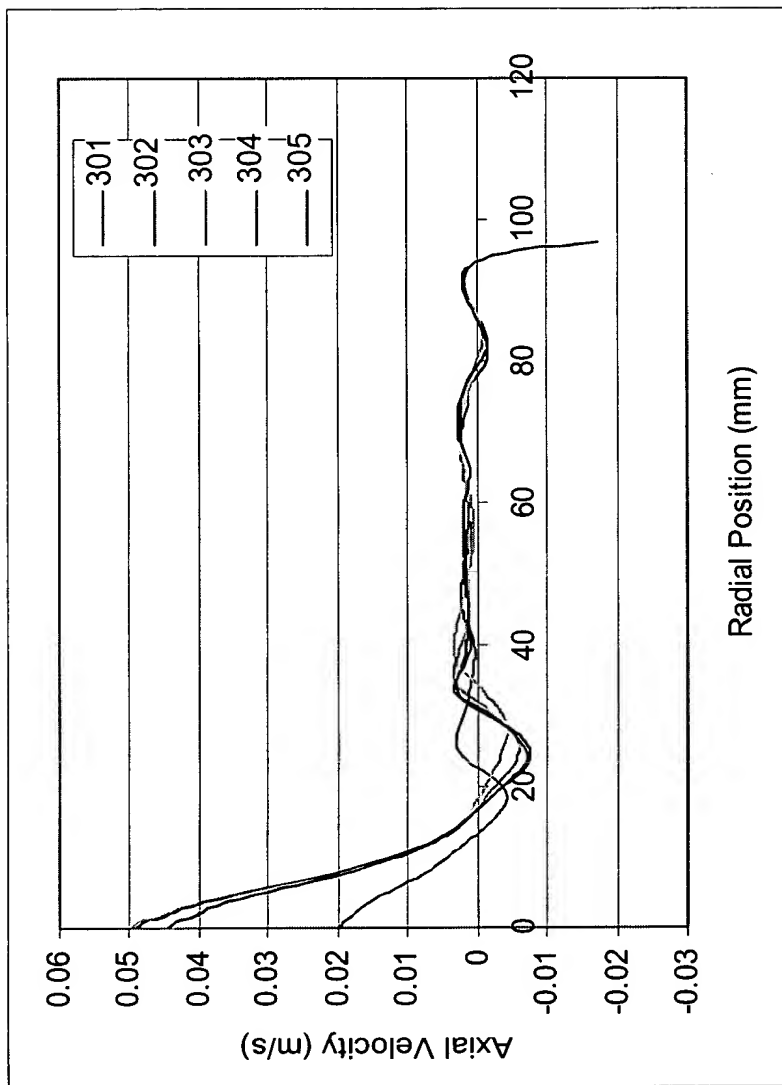


FIG. 4

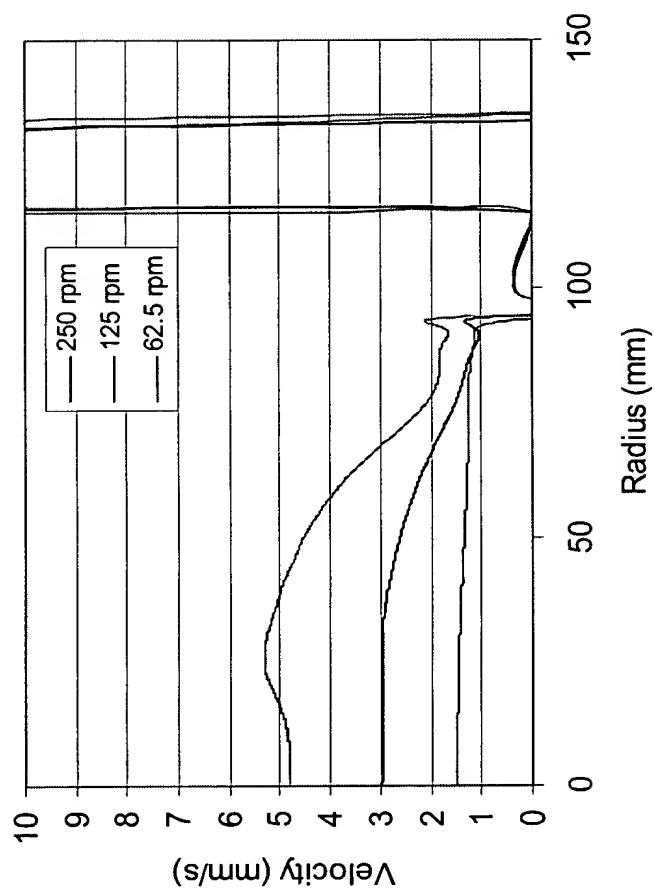


FIG. 5

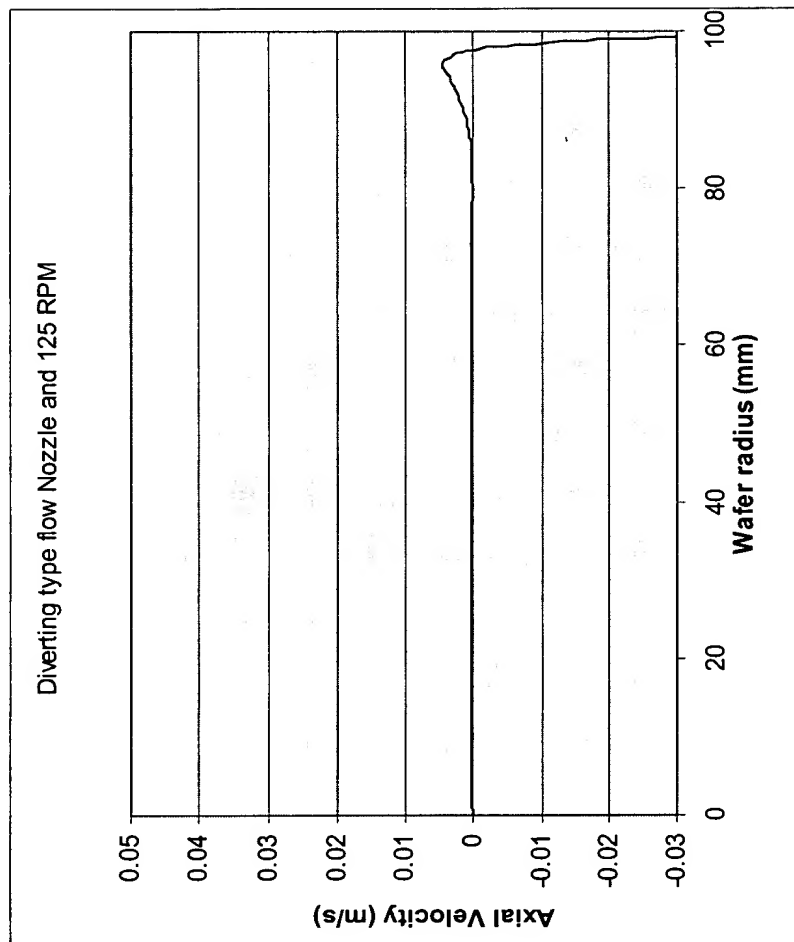


FIG. 6

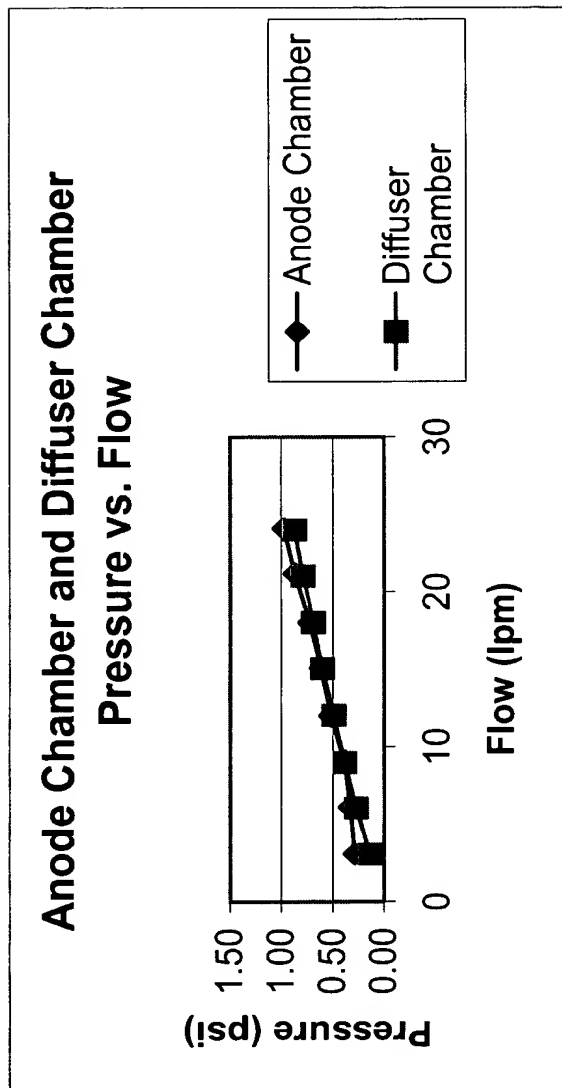


FIG. 7

PATENT APPLICATION

METHODS AND APPARATUS FOR CONTROLLING ELECTROLYTE
FLOW FOR UNIFORM PLATING

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